

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









MODEL: SP-1813

PRODUCT: Dynamic Speaker

EDITION: A/2016



THIS SPECIFICATION COVERS OUR PRODUCT OF DYNAMIC SPEAKER UNIT FOR MOBILE PHONE USE

DYNAMIC SPEAKER ELECTORACOUSTIC CHARACTERISTICS

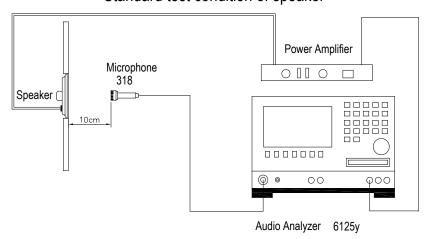
sound pressure level	89±3dB SPL @0.8, 1.0, 1.2, 1.5, 1.8 and 2.0KHz in average (0dB SPL=20μPa)
measuring condition	0.1W (Sine wave) 10cm measured with baffler
frequency response curve	As shown in Fig.2
response frequency	900±20%Hz @ 1V. (without baffler)
rated noise power	0.5W
short-term max. power	0.8W must be normal at a white noise (1W, F0-20KHz) for 1 minute
 distortion	Less than 10% @1KHz, 0.1M, 0.5W frequency range, input level up to 0.2Vrms
 operation test	Must be free audible noise (buzzes and rattles)
	300 ~8KHz frequency range, input level up to 2.0Vrms

GENERAL SPECIFICATIONS

operating tem	nperature -20°C ~	+60℃
standard test	conditions	
	temperature	17°C ~ 25°C
	relative humidity	45% ~ 80%(RH)
ac impedance	8±15%	Ω (@1.5KHz 1V) without baffler
dimensions	Ø9.8*4.	2

MEASURING METHOD (SPEAKER MODE) (Figure 1)

Standard test condition of speaker



TEST CONDITION			
STANDARD	ANDARD		
temperature	15 ~ 35℃		
relative humdity	45% ~ 85%		
atmospheric pressure	860mbar to 1060mbar.		
STANDARD TEST FIXTUI	RE		
input power	0.1W (0.89V)		
zero level	-dB		
mode	TSR		
potentiometer range	50dB		
sweep time	0.5sec		



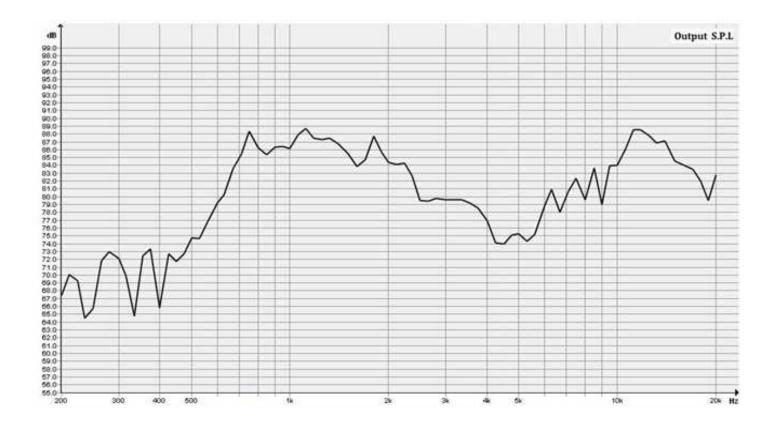
MODEL: SP-1813

PRODUCT: Dynamic Speaker

EDITION: A/2016

Soberton Inc.

TYPICAL FREQUENCY RESPONSE CURVE (Figure 2)





MODEL: SP-1813

PRODUCT: Dynamic Speaker

EDITION: A/2016

Soberton Inc.

RELIABILITY TESTS

The sound pressure as specified shall neither deviate more than $\pm 3 dB$ from the initial value, nor have any significant damage after any of following testing.

HIGH	TEMP	JRF TFS1	Г

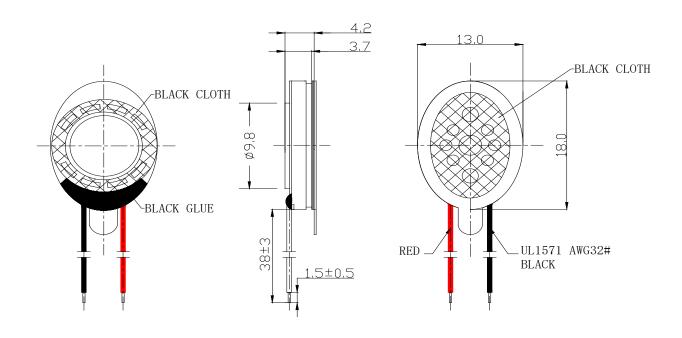
HIGH TEMPERATURE TEST	
high temperature	+60±2°C
duration	96 hours
LOW TEMPERATURE TEST	
 low temperature	-20±2°C
duration	96 hours
HEAT SHOCK TEST	
high temperature	+60±2°C
low temperature	-20±2°C
duration	1 hour
 changeover time	< 30 seconds
cycle	100
 HUMIDITY TEST	
 temperature	+40±2°C
 relative humidity	90~95%
 duration	96 hours
 TEMPERATURE CYCLE TEST	
 temperature	-20°C +60°C
 duration	45 minutes 45 minutes
 temperature gradient	1~3°C/min.
 cycle	25
 DROP TEST	
mounted with dummy set	100 g
 mass	
 height	1.5 m
 cycle	6 (1 each plain) onto the concrete board
 LOAD TEST	
 noise signal	White noise (EIA filter)
 input power	0.5W
 duration	96 hours

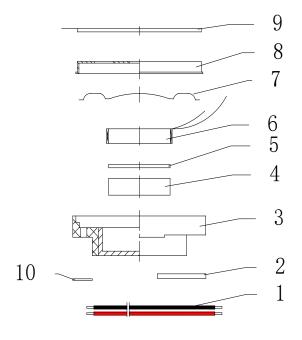


Soberton Inc.

DIMENSIONS

Tolerance: ±0.5 (unit: mm)





no	item	material	quantity
1	UL1571 AWG32#	Wire Red/Black	2
2	PCB	Epoxy glass fiber	1
3	Frame	PBT	1
4	Magnet	ND Fe B-N38	1
5	Plate	SPCC	1
6	Voice Coil	Copper	1
7	Membrane	PEN	1
8	Cap	SUS 304	1
9	Gasket	Polyester fiber	1
10	Damping cloth	Non-woven fabrics	1



EDITION: A/2016

Soberton Inc.

PACKING

